

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







# PQ1Lxx3M2SP Series

Compact Surface Mount Type, Low Output Current, Low Power-Loss Voltage Regulators

#### Features

• Compact surface mount package SOT-89 (4.5×4.3×1.5 mm)

Output current : MAX.300mAPower dissipation : MAX.900mW

• Low power-loss

(Dropout voltage: MAX.0.7 V at Io=300mA)

• High ripple rejection (TYP. 70dB)

• Built-in output ON/OFF control function

# Applications

- CD-ROM drives
- DVD-ROM drives
- Digital Still Cameras

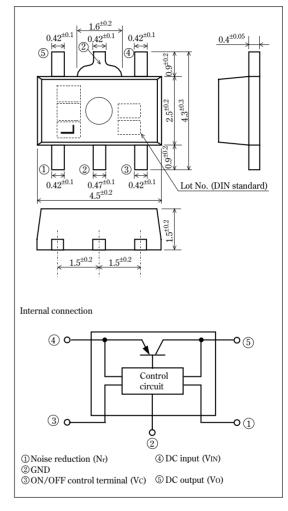
### Absolute Maximum Ratings

(Ta=25°C)

	•	(2.	0 0)
Parameter	Symbol	Rating	Unit
*1 Input voltage	Vin	16	V
*1 ON/OFF control terminal voltage	Vc	16	V
Output current	Io	300	mA
*2 Power dissipation	PD	900	mW
*3 Junction temperature	Tj	150	°C
Operating temperature	Topr	-30 to + 80	°C
Storage temperature	Tstg	-55 to +150	°C
Soldering temperature	Tsol	260(For 10s)	°C

 $<sup>\$1\,</sup>$  All are open except GND and applicable terminals.

### Outline Dimensions (Unit : mm)



<sup>\*2</sup> At mounted on PCB

<sup>\*3</sup> Overheat protection may operate at  $125 \le T_j \le 150$ °C.

<sup>•</sup> Please refer to the chapter " Handling Precautions ".

#### **Electrical Characteristics**

(Unless otherwise specified, condition shall be V<sub>IN</sub>=V<sub>O</sub>(TYP.)+1V, Io=0.5A,Vc=2.7V, Ta=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output voltage	Vo	_	Refer to the table below		V	
Load regulation	RegL	Io=5mA to 300mA	-	35	160	mV
Line regulation	RegI	Vin=Vo(TYP.)+1V to Vo(TYP.)+6V	-	3	20	mV
Temperature coefficient of output voltage	TcVo	Io=10mA, Tj=-25 to +75°C	-	0.05	_	mV/°C
*4 Ripple rejection	RR	_	-	70	-	dB
*4 Output noise voltage	V <sub>no(rms)</sub>	10Hz <f<100khz, c<sub="" io="30mA,">n=0.1μF</f<100khz,>	-	30	_	μV
Dropout voltage	$V_{i-o}$	Io=300mA *5	_	0.3	0.7	V
*6 ON-state voltage for control	Vc(on)	-	1.8	_	_	V
ON-state current for control	Ic(on)	Vc=1.8V	-	5	30	μA
OFF-state voltage for control	V <sub>C(OFF)</sub>	-	-	_	0.4	V
Quienscent current	$I_{\mathrm{q}}$	Io=0mA	-	150	500	μA
Output OFF-state dissipation current	$I_{\rm qs}$	Vc=0.2V	_	_	1	μA

<sup>\*4</sup> Typical value at output voltage is 3.0V type.

## Output Voltage Line-up

(V<sub>IN</sub>=V<sub>O</sub>(TYP.)+1.0V, I<sub>O</sub>=30mA, V<sub>C</sub>=1.8V, T<sub>a</sub>=25°C)

Para	meter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
	PQ1L253M2SP			2.440	2.5	2.560	
Output voltage PQ1L303M2SP PQ1L333M2SP PQ1L503M2SP	Vo –		2.940	3.0	3.060	W	
		3.234	3.3	3.366	\ \ \		
	PQ1L503M2SP			4.900	5.0	5.100	

**Test Cirsuit** 

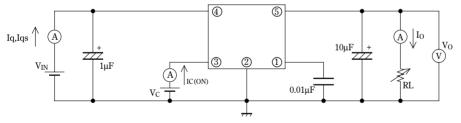
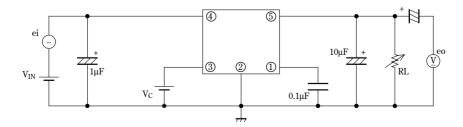
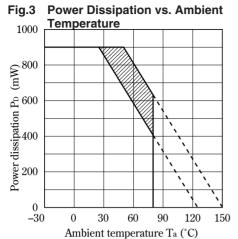


Fig.2 Test Circuit for Ripple Rejection



<sup>\*\*5</sup> Input voltage when output voltage lowers 100mV from the voltage at Vin=Vo(TYP.)+1.0V. \*\*6 In case of opening control terminal ③, output voltage turns off.



Note) Oblique line portion: Overheat protection may operate in this area.

Fig.5 Output Voltage Fluctuation vs. Junction Temperature (PQ1L333M2SP) (Typical Value)

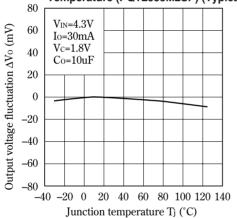
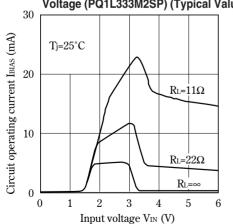


Fig.7 Circuit Operating Current vs. Input Voltage (PQ1L333M2SP) (Typical Value)



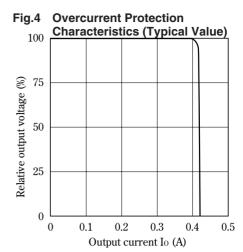


Fig.6 Output Voltage vs. Input Voltage (PQ1L333MS2SP) (Typical Value)

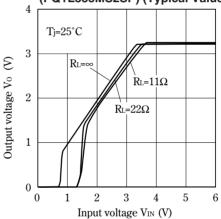


Fig.8 Dropout Voltage vs. Junction Temperature (Typical Value)

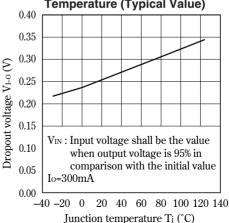


Fig.9 Quiescent Current vs. Junction Temperature

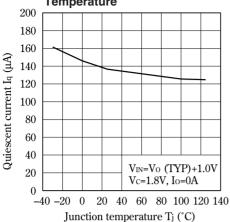


Fig.11 Dropout Voltage vs. Output Current (Typical Value)

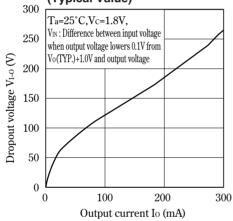


Fig.10 Ripple Rejection vs. Input Ripple Frequency (PQ1L333M2SP) (Typical Value)

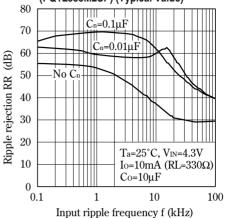
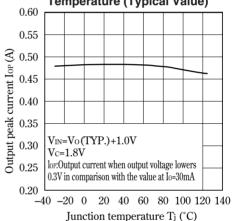
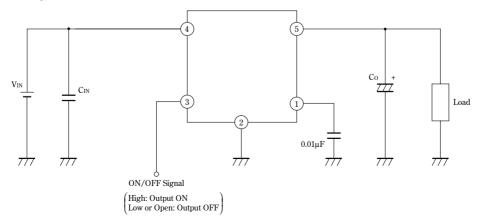


Fig.12 Output Peak Current vs. Junction Temperature (Typical Value)



#### ON/OFF Operation



#### NOTICE

- The circuit application examples in this publication are provided to explain representative applications of SHARP
  devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes
  no responsibility for any problems related to any intellectual property right of a third party resulting from the use of
  SHARP's devices.
- Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP
  reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents
  described herein at any time without notice in order to improve design or reliability. Manufacturing locations are
  also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage
  caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used
  specified in the relevant specification sheet nor meet the following conditions:
  - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
    - --- Personal computers
    - --- Office automation equipment
    - --- Telecommunication equipment [terminal]
    - --- Test and measurement equipment
    - --- Industrial control
    - --- Audio visual equipment
    - --- Consumer electronics
  - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
    - --- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
    - --- Traffic signals
    - --- Gas leakage sensor breakers
    - --- Alarm equipment
    - --- Various safety devices, etc.
  - (iii)SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
    - --- Space applications
    - --- Telecommunication equipment [trunk lines]
    - --- Nuclear power control equipment
    - --- Medical and other life support equipment (e.g., scuba).
- If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.